

PATENT ASSIGNMENT

Electronic Version v1.1
 Stylesheet Version v1.1

SUBMISSION TYPE:	CORRECTIVE ASSIGNMENT
NATURE OF CONVEYANCE:	Corrective Assignment to correct the inventor's last name previously recorded on Reel 026122 Frame 0081. Assignor(s) hereby confirms the Assignor's interest.
CONVEYING PARTY DATA	
Name	Execution Date
Takashi KANSAKU	04/04/2011
RECEIVING PARTY DATA	
Name:	ELPIDA MEMORY, INC.
Street Address:	2-1, Yaesu 2-chome, Chuo-ku
City:	Tokyo
State/Country:	JAPAN
Postal Code:	104-0028
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	13085782
CORRESPONDENCE DATA	
Fax Number:	(202)293-7860
<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>	
Email:	ywilliams@sughrue.com
Correspondent Name:	Sughrue Mion, PLLC
Address Line 1:	2100 Pennsylvania Ave. NW
Address Line 2:	Suite 800
Address Line 4:	Washington, DISTRICT OF COLUMBIA 20037
ATTORNEY DOCKET NUMBER:	Q124110
NAME OF SUBMITTER:	Yukiko Williams/New Apps Specialist
Total Attachments: 4 source=Corrective_Assignment#page1.tif source=Corrective_Assignment#page2.tif source=Corrective_Assignment#page3.tif source=Assignment_Executed#page1.tif	

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04/13/2011
 501500008

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
Takashi KANASAKU	04/04/2011
RECEIVING PARTY DATA	
Name:	ELPIDA MEMORY, INC.
Street Address:	2-1, Yaesu 2-chome, Chuo-ku
City:	Tokyo
State/Country:	JAPAN
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Phone:	202-293-7060
Email:	ywilliams@sughrue.com
Correspondent Name:	SUGHRUE MION, PLLC
Address Line 1:	2100 PENNSYLVANIA AVENUE, N.W.
Address Line 2:	SUITE 800
Address Line 4:	WASHINGTON, DISTRICT OF COLUMBIA 20037
ATTORNEY DOCKET NUMBER:	Q124110
NAME OF SUBMITTER:	Yukiko Williams/New Apps Specialist
Total Attachments: 1 source=Assignment_Executed#page1.tif	

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Assignment

Whereas, I/~~We~~, Takashi KANSAKU of
Tokyo, Japan

hereinafter called assignor(s), have invented certain improvements in
METHOD FOR MANUFACTURING SEMICONDUCTOR DEVICE

and executed an application for Letters Patent of the United States of America therefor on
April 4, 2011; and

Whereas, Elpida Memory, Inc.
2-1, Yaesu 2-chome, Chuo-ku,
Tokyo 104-0028 Japan

(assignee), desires to acquire the entire right, title, and interest in the application and invention, and to any United States patents to be obtained therefor;

Now therefore, for valuable consideration, receipt whereof is hereby acknowledged,

I/~~We~~, the above named assignor(s), hereby sell, assign and transfer to the above named assignee, its successors and assigns, the entire right, title and interest in the application and the invention disclosed therein for the United States of America, including the right to claim priority under 35 U.S.C. §119, and I/~~We~~ request the Director – U.S. Patent and Trademark Office to issue any Letters Patent granted upon the invention set forth in the application to the assignee, its successors and assigns; and I/~~We~~ will execute without further consideration all papers deemed necessary by the assignee in connection with the United States application when called upon to do so by the assignee.

I/~~We~~ hereby authorize and request our attorneys SUGHRUE MION, PLLC of 2100 Pennsylvania Avenue, NW, Washington, DC 20037-3213 to insert here in parentheses (Application number 13/085,782 and Confirmation number 2794, filed April 13, 2011) the filing date and application number of said application when known.

Date: April 4, 2011 Takashi Kansaku (神作)
s/ Takashi KANSAKU
Date: _____
s/ _____
Date: _____
s/ _____
Date: _____
s/ _____

(Legalization not required for recording but is prima facie evidence of execution under 35 U.S.C. §261)

Witness: [Signature]